

# EMK12G2H-115.000M TR

[Click part number to visit Part Number Details page](#)

## REGULATORY COMPLIANCE (Data Sheet downloaded on Sep 9, 2016)


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## ITEM DESCRIPTION

MEMS Clock Oscillators LVCMOS (CMOS) 2.5Vdc 4 Pad 5.0mm x 7.0mm Plastic Surface Mount (SMD) 115.000MHz  $\pm 100$ ppm over -40°C to +85°C

## ELECTRICAL SPECIFICATIONS

|                                 |                                                                                                                                                                                                                                                                           |
|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Nominal Frequency               | 115.000MHz                                                                                                                                                                                                                                                                |
| Frequency Tolerance/Stability   | $\pm 100$ ppm Maximum over -40°C to +85°C (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, 260°C Reflow, Shock, and Vibration) |
| Aging at 25°C                   | $\pm 1$ ppm Maximum First Year                                                                                                                                                                                                                                            |
| Supply Voltage                  | 2.5Vdc $\pm 5\%$                                                                                                                                                                                                                                                          |
| Input Current                   | 20mA Maximum                                                                                                                                                                                                                                                              |
| Output Voltage Logic High (Voh) | 90% of Vdd Minimum (IOH=-8mA)                                                                                                                                                                                                                                             |
| Output Voltage Logic Low (Vol)  | 10% of Vdd Maximum (IOL=+8mA)                                                                                                                                                                                                                                             |
| Rise/Fall Time                  | 2nSec Maximum (Measured from 20% to 80% of waveform)                                                                                                                                                                                                                      |
| Duty Cycle                      | 50 $\pm 5\%$ (Measured at 50% of waveform)                                                                                                                                                                                                                                |
| Load Drive Capability           | 15pF Maximum                                                                                                                                                                                                                                                              |
| Output Logic Type               | CMOS                                                                                                                                                                                                                                                                      |
| Output Control Function         | Tri-State (Disabled Output: High Impedance)                                                                                                                                                                                                                               |
| Output Control Input Voltage    | +0.7Vdd Minimum or No Connect to Enable Output, +0.3Vdd Maximum to Disable Output                                                                                                                                                                                         |
| Peak to Peak Jitter (tPK)       | 250pSec Maximum, 100pSec Typical                                                                                                                                                                                                                                          |
| Start Up Time                   | 50mSec Maximum                                                                                                                                                                                                                                                            |
| Storage Temperature Range       | -55°C to +125°C                                                                                                                                                                                                                                                           |

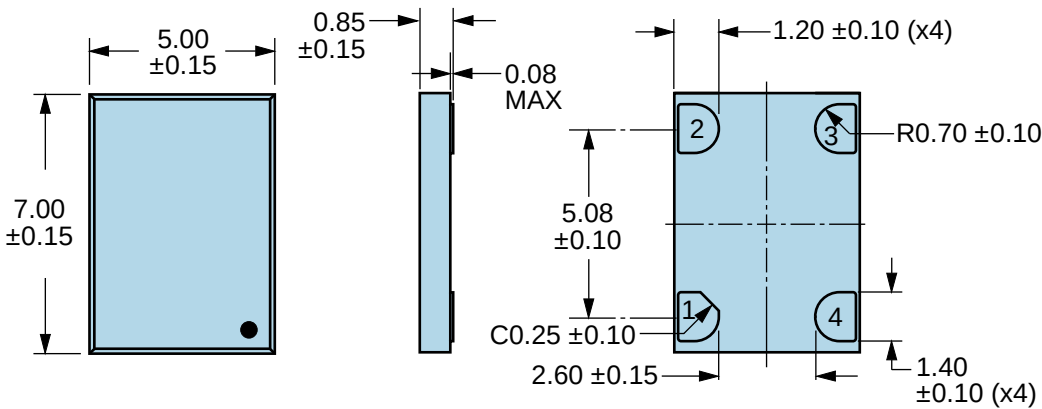
## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                                                    |
|------------------------------|--------------------------------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 2, HBM 2000V                       |
| Flammability                 | UL94-V0                                                            |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition G, 30,000G                     |
| Moisture Resistance          | MIL-STD-883, Method 1004                                           |
| Moisture Sensitivity Level   | J-STD-020, MSL 1                                                   |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K                               |
| Resistance to Solvents       | MIL-STD-202, Method 215                                            |
| Solderability                | MIL-STD-883, Method 2003 (Four I/O Pads on bottom of package only) |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B                              |
| Thermal Shock                | MIL-STD-883, Method 1011, Condition B                              |
| Vibration                    | MIL-STD-883, Method 2007, Condition A, 20G                         |

EMK12G2H-115.000M TR [Click part number to visit Part Number Details page](#)



MECHANICAL DIMENSIONS (all dimensions in millimeters)

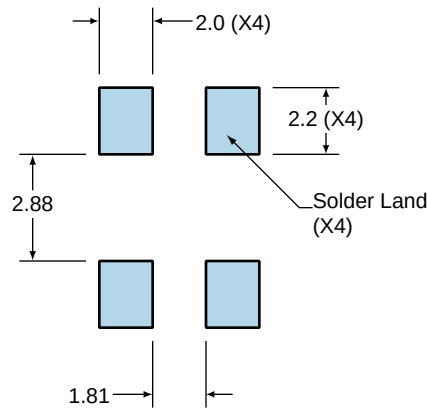


| PIN | CONNECTION                 |
|-----|----------------------------|
| 1   | Tri-State (High Impedance) |
| 2   | Ground                     |
| 3   | Output                     |
| 4   | Supply Voltage             |

| LINE | MARKING                                             |
|------|-----------------------------------------------------|
| 1    | XXXXXX<br>XXXXXX=Ecliptek<br>Manufacturing Lot Code |

Suggested Solder Pad Layout

All Dimensions in Millimeters

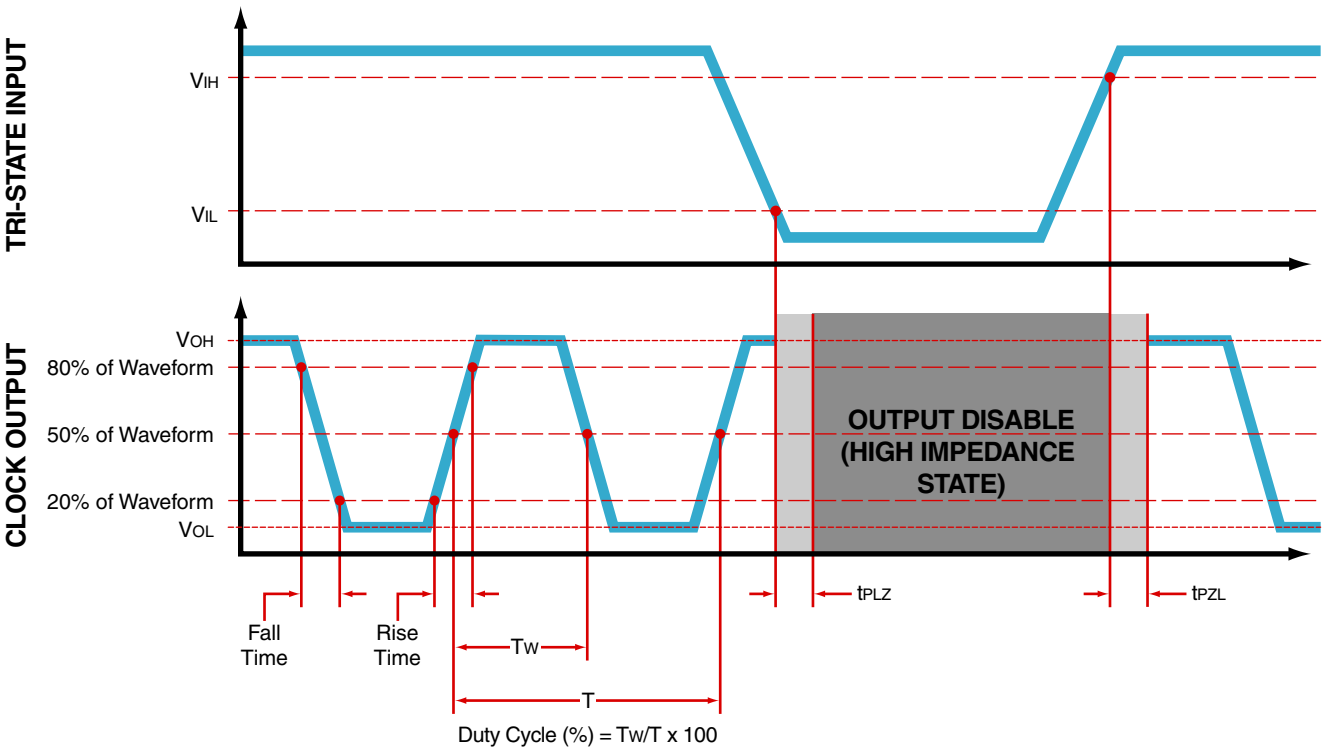


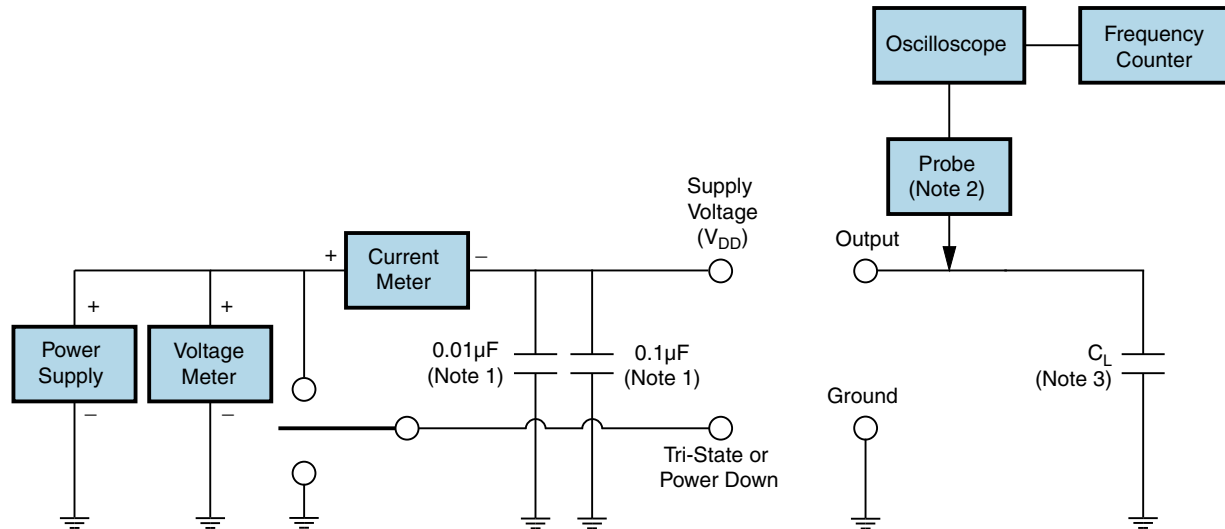
All Tolerances are ±0.1

EMK12G2H-115.000M TR [Click part number to visit Part Number Details page](#)



OUTPUT WAVEFORM & TIMING DIAGRAM



**EMK12G2H-115.000M TR**
[Click part number to visit Part Number Details page](#)
**Test Circuit for CMOS Output**

Note 1: An external 0.01 $\mu$ F ceramic bypass capacitor in parallel with a 0.1 $\mu$ F high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low input capacitance (<12pF), 10X Attenuation Factor, High Impedance (>10Mohms), and High bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance. See applicable specification sheet for 'Load Drive Capability'.

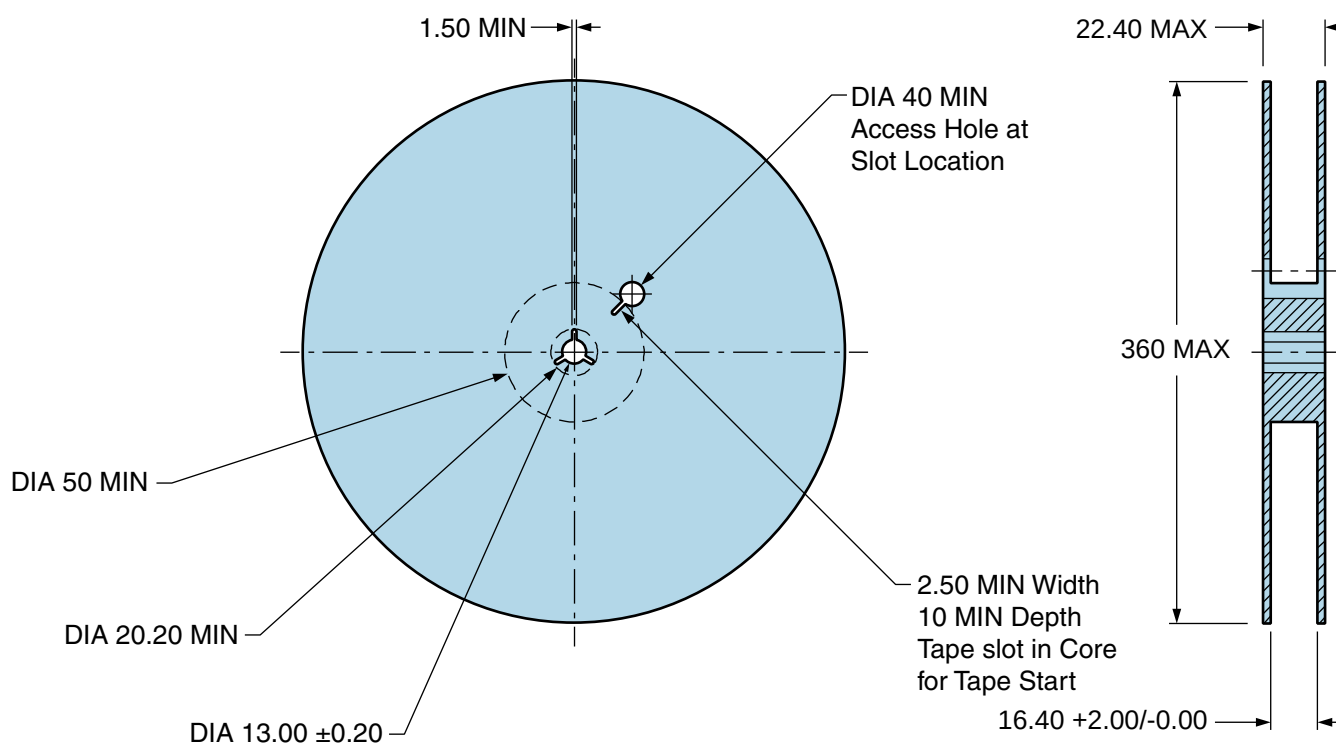
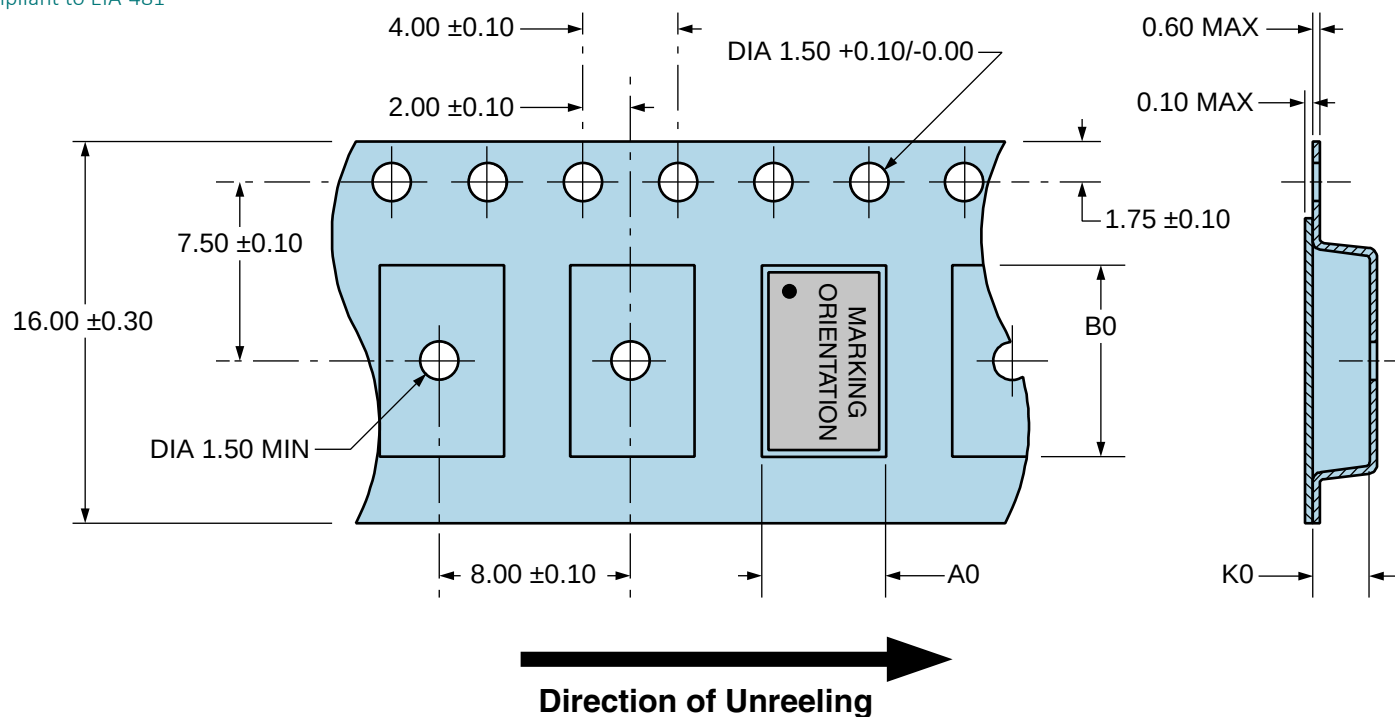
# EMK12G2H-115.000M TR

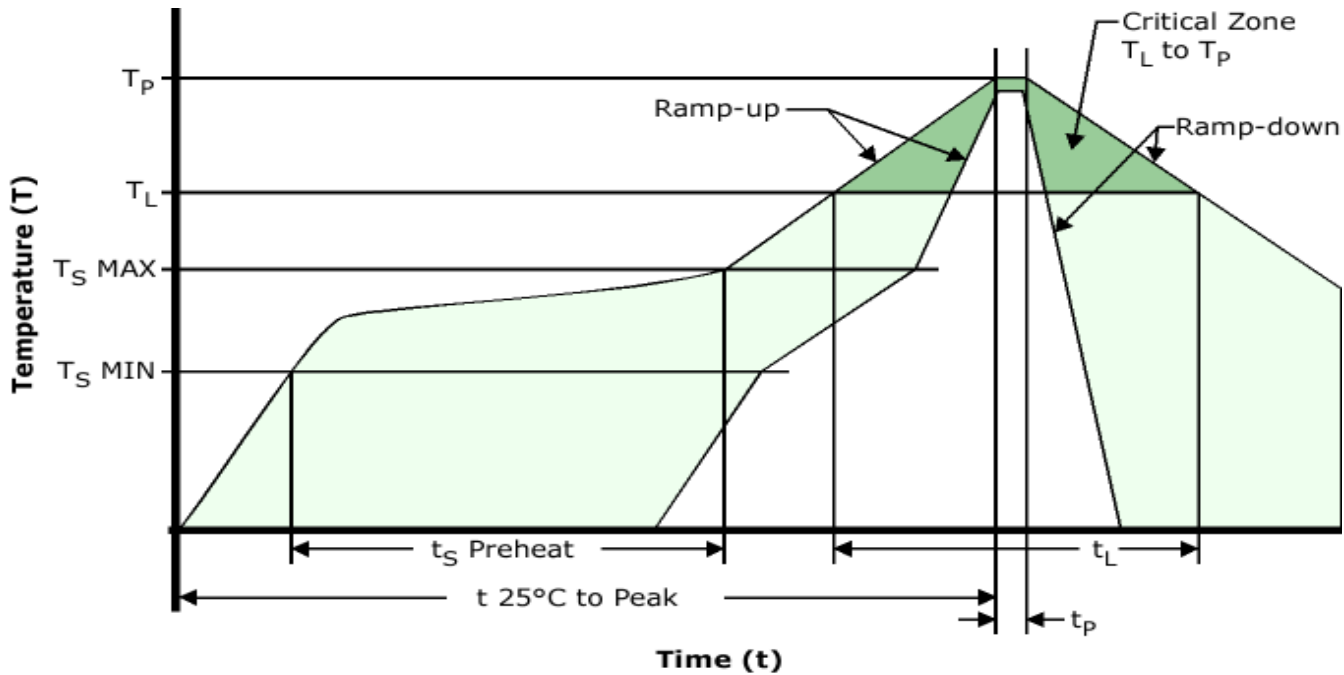
## Tape & Reel Dimensions

Quantity Per Reel: 1,000 units

All Dimensions in Millimeters

Compliant to EIA-481



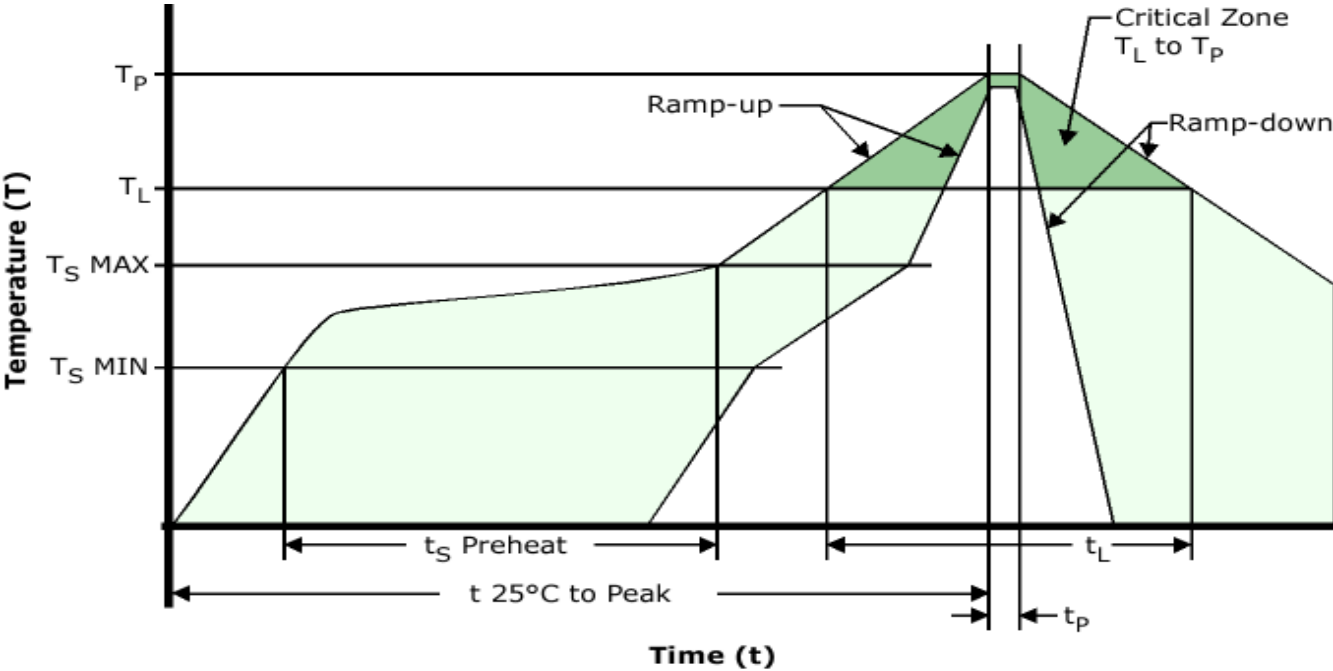
**EMK12G2H-115.000M TR**
[Click part number to visit Part Number Details page](#)
**Recommended Solder Reflow Methods****High Temperature Infrared/Convection**

|                                            |                                      |
|--------------------------------------------|--------------------------------------|
| <b>TS MAX to TL (Ramp-up Rate)</b>         | 3°C/Second Maximum                   |
| <b>Preheat</b>                             |                                      |
| - Temperature Minimum (TS MIN)             | 150°C                                |
| - Temperature Typical (TS TYP)             | 175°C                                |
| - Temperature Maximum (TS MAX)             | 200°C                                |
| - Time (ts MIN)                            | 60 - 180 Seconds                     |
| <b>Ramp-up Rate (TL to TP)</b>             | 3°C/Second Maximum                   |
| <b>Time Maintained Above:</b>              |                                      |
| - Temperature (TL)                         | 217°C                                |
| - Time (tL)                                | 60 - 150 Seconds                     |
| <b>Peak Temperature (TP)</b>               | 260°C Maximum for 10 Seconds Maximum |
| <b>Target Peak Temperature (TP Target)</b> | 250°C +0/-5°C                        |
| <b>Time within 5°C of actual peak (tp)</b> | 20 - 40 Seconds                      |
| <b>Ramp-down Rate</b>                      | 6°C/Second Maximum                   |
| <b>Time 25°C to Peak Temperature (t)</b>   | 8 Minutes Maximum                    |
| <b>Moisture Sensitivity Level</b>          | Level 1                              |

EMK12G2H-115.000M TR [Click part number to visit Part Number Details page](#)



Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 240°C

|                                     |                                                        |
|-------------------------------------|--------------------------------------------------------|
| TS MAX to TL (Ramp-up Rate)         | 5°C/Second Maximum                                     |
| Preheat                             |                                                        |
| - Temperature Minimum (TS MIN)      | N/A                                                    |
| - Temperature Typical (TS TYP)      | 150°C                                                  |
| - Temperature Maximum (TS MAX)      | N/A                                                    |
| - Time (ts MIN)                     | 60 - 120 Seconds                                       |
| Ramp-up Rate (TL to TP)             | 5°C/Second Maximum                                     |
| Time Maintained Above:              |                                                        |
| - Temperature (TL)                  | 150°C                                                  |
| - Time (tL)                         | 200 Seconds Maximum                                    |
| Peak Temperature (TP)               | 240°C Maximum                                          |
| Target Peak Temperature (TP Target) | 240°C Maximum 2 Times / 230°C Maximum 1 Time           |
| Time within 5°C of actual peak (tp) | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
| Ramp-down Rate                      | 5°C/Second Maximum                                     |
| Time 25°C to Peak Temperature (t)   | N/A                                                    |
| Moisture Sensitivity Level          | Level 1                                                |

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.